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(54) Title: METHOD OF MAKING A SUBSTRATE HAVING MULTI-LAYERED STRUCTURES

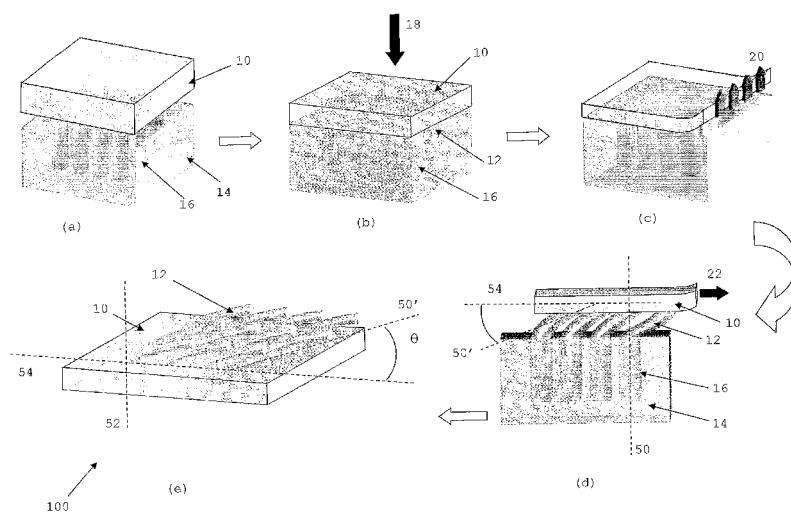


Fig. 1

(57) Abstract: A method of making a substrate having multi-layered structures thereon, the method comprising the steps of (a) applying a mold having an imprint forming surface to the substrate to form an array of imprint structures that projects from the substrate; and (b) applying a lateral force that is substantially normal to said projecting imprint structures to cause said imprint structures to move angularly towards said substrate and thereby form a pattern of multi-layered structures thereon.